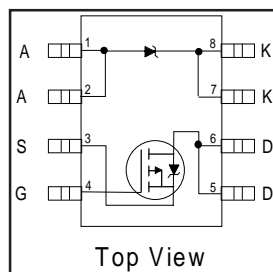


**FETKY™ MOSFET & Schottky Diode**

- Co-packaged HEXFET® Power MOSFET and Schottky Diode
- P-Channel HEXFET
- Low  $V_F$  Schottky Rectifier
- Generation 5 Technology
- Micro8™ Footprint

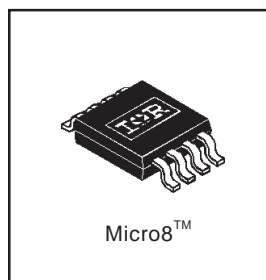


$V_{DSS} = -20V$   
 $R_{DS(on)} = 0.27\Omega$   
 Schottky  $V_f = 0.39V$

**Description**

The **FETKY™** family of co-packaged HEXFETs and Schottky diodes offer the designer an innovative board space saving solution for switching regulator applications. Generation 5 HEXFETs utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. Combining this technology with International Rectifier's low forward drop Schottky rectifiers results in an extremely efficient device suitable for use in a wide variety of portable electronics applications like cell phone, PDA, etc.

The new Micro8™ package, with half the footprint area of the standard SO-8, provides the smallest footprint available in an SOIC outline. This makes the Micro8™ an ideal device for applications where printed circuit board space is at a premium. The low profile (<1.1mm) of the Micro8™ will allow it to fit easily into extremely thin application environments such as portable electronics and PCMCIA cards.

**Absolute Maximum Ratings**

Parameter	Maximum	Units	
$I_D @ T_A = 25^\circ C$	-1.7	A	
$I_D @ T_A = 70^\circ C$	-1.4		
$I_{DM}$	-14		
$P_D @ T_A = 25^\circ C$	1.25	W	
$P_D @ T_A = 70^\circ C$	0.8		
	Linear Derating Factor	10	mW/°C
$V_{GS}$	Gate-to-Source Voltage	$\pm 12$	V
$dv/dt$	Peak Diode Recovery $dv/dt$ ②	-5.0	V/ns
$T_J, T_{STG}$	Junction and Storage Temperature Range	-55 to +150	°C

**Thermal Resistance Ratings**

Parameter	Maximum	Units	
$R_{\theta JA}$	Junction-to-Ambient ④	100	°C/W

**Notes:**

- ① Repetitive rating – pulse width limited by max. junction temperature (see Fig. 9)
- ②  $I_{SD} \leq -1.2A$ ,  $di/dt \leq 100A/\mu s$ ,  $V_{DD} \leq V_{(BR)DSS}$ ,  $T_J \leq 150^\circ C$
- ③ Pulse width  $\leq 300\mu s$  – duty cycle  $\leq 2\%$
- ④ When mounted on 1 inch square copper board to approximate typical multi-layer PCB thermal resistance

www.irf.com

**MOSFET Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)**

	Parameter	Min.	Typ.	Max.	Units	Conditions
V <sub>(BR)DSS</sub>	Drain-to-Source Breakdown Voltage	-20	—	—	V	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA
R <sub>DS(on)</sub>	Static Drain-to-Source On-Resistance	—	0.17	0.27	Ω	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -1.2A ③
		—	0.28	0.40		V <sub>GS</sub> = -2.7V, I <sub>D</sub> = -0.60A ③
V <sub>GS(th)</sub>	Gate Threshold Voltage	-0.70	—	—	V	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA
g <sub>fs</sub>	Forward Transconductance	1.3	—	—	S	V <sub>DS</sub> = -10V, I <sub>D</sub> = -0.60A
I <sub>DSS</sub>	Drain-to-Source Leakage Current	—	—	-1.0	μA	V <sub>DS</sub> = -16V, V <sub>GS</sub> = 0V
		—	—	-25		V <sub>DS</sub> = -16V, V <sub>GS</sub> = 0V, T <sub>J</sub> = 125°C
I <sub>GSS</sub>	Gate-to-Source Forward Leakage	—	—	-100	nA	V <sub>GS</sub> = -12V
	Gate-to-Source Reverse Leakage	—	—	100		V <sub>GS</sub> = 12V
Q <sub>g</sub>	Total Gate Charge	—	5.4	8.2	nC	I <sub>D</sub> = -1.2A
Q <sub>gs</sub>	Gate-to-Source Charge	—	0.96	1.4		V <sub>DS</sub> = -16V
Q <sub>gd</sub>	Gate-to-Drain ("Miller") Charge	—	2.4	3.6		V <sub>GS</sub> = -4.5V, See Fig. 6 ③
t <sub>d(on)</sub>	Turn-On Delay Time	—	9.1	—	ns	V <sub>DD</sub> = -10V
t <sub>r</sub>	Rise Time	—	35	—		I <sub>D</sub> = -1.2A
t <sub>d(off)</sub>	Turn-Off Delay Time	—	38	—		R <sub>G</sub> = 6.0Ω
t <sub>f</sub>	Fall Time	—	43	—		R <sub>D</sub> = 8.3Ω, ③
C <sub>iss</sub>	Input Capacitance	—	240	—		V <sub>GS</sub> = 0V
C <sub>oss</sub>	Output Capacitance	—	130	—	pF	V <sub>DS</sub> = -15V
C <sub>rss</sub>	Reverse Transfer Capacitance	—	64	—		f = 1.0MHz, See Fig. 5

**MOSFET Source-Drain Ratings and Characteristics**

	Parameter	Min.	Typ.	Max.	Units	Conditions
I <sub>S</sub>	Continuous Source Current(Body Diode)	—	—	-1.25	A	
I <sub>SM</sub>	Pulsed Source Current (Body Diode)	—	—	-9.6		
V <sub>SD</sub>	Body Diode Forward Voltage	—	—	-1.2	V	T <sub>J</sub> = 25°C, I <sub>S</sub> = -1.2A, V <sub>GS</sub> = 0V
t <sub>rr</sub>	Reverse Recovery Time (Body Diode)	—	52	78	ns	T <sub>J</sub> = 25°C, I <sub>F</sub> = -1.2A
Q <sub>rr</sub>	Reverse Recovery Charge	—	63	95	nC	di/dt = 100A/μs ③

**Schottky Diode Maximum Ratings**

	Parameter	Max.	Units	Conditions
I <sub>F(av)</sub>	Max. Average Forward Current	1.9	A	50% Duty Cycle. Rectangular Wave, T <sub>A</sub> = 25°C See Fig.14 T <sub>A</sub> = 70°C
		1.4		
I <sub>SM</sub>	Max. peak one cycle Non-repetitive Surge current	120	A	Following any rated load condition & with V <sub>RRM</sub> applied
		11		

**Schottky Diode Electrical Specifications**

	Parameter	Max.	Units	Conditions
V <sub>FM</sub>	Max. Forward voltage drop	0.50	V	I <sub>F</sub> = 1.0A, T <sub>J</sub> = 25°C
		0.62		I <sub>F</sub> = 2.0A, T <sub>J</sub> = 25°C
		0.39		I <sub>F</sub> = 1.0A, T <sub>J</sub> = 125°C
		0.57		I <sub>F</sub> = 2.0A, T <sub>J</sub> = 125°C .
I <sub>RM</sub>	Max. Reverse Leakage current	0.02	mA	V <sub>R</sub> = 20V
		8		T <sub>J</sub> = 125°C
C <sub>t</sub>	Max. Junction Capacitance	92	pF	V <sub>R</sub> = 5Vdc ( 100kHz to 1 MHz) 25°C
dv/dt	Max. Voltage Rate of Charge	3600	V/ μs	Rated V <sub>R</sub>

(HEXFET is the reg. TM for International Rectifier Power MOSFET's )

Power Mosfet Characteristics

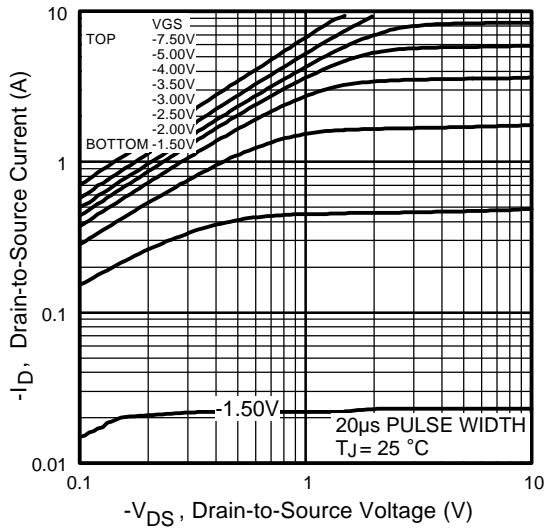


Fig 1. Typical Output Characteristics

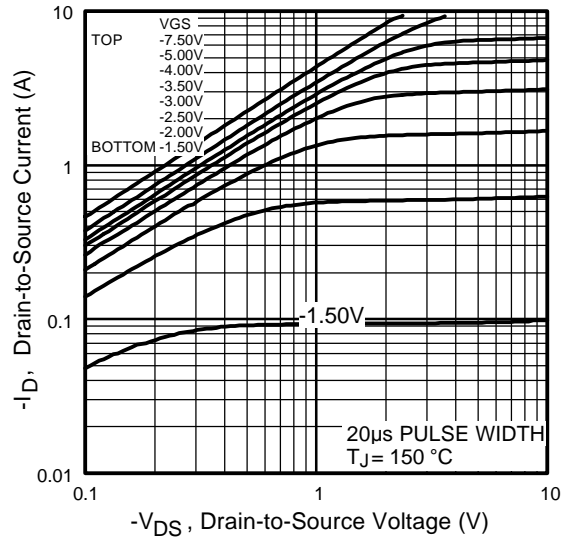


Fig 2. Typical Output Characteristics

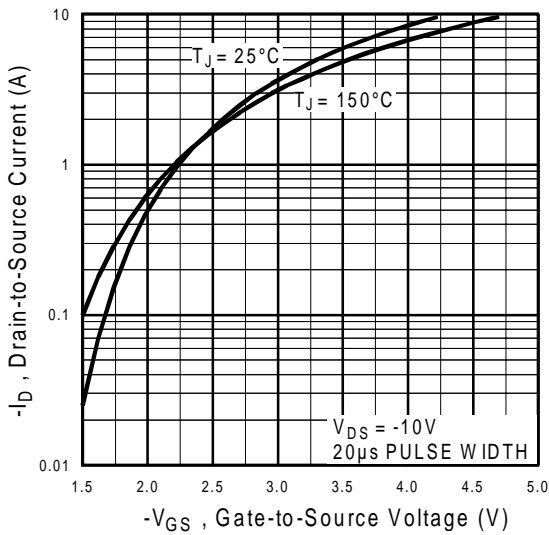


Fig 3. Typical Transfer Characteristics

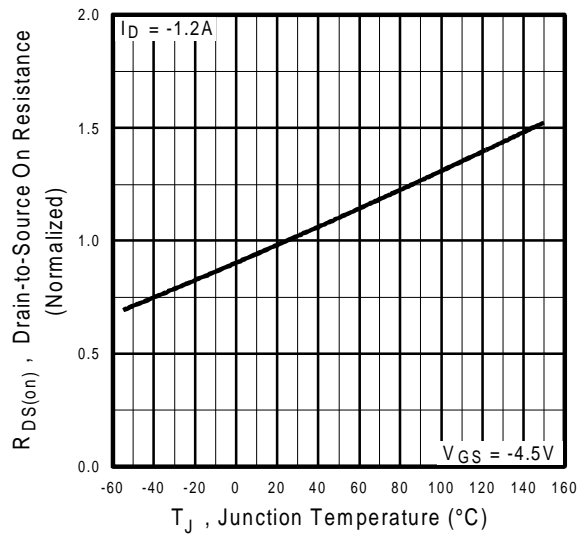
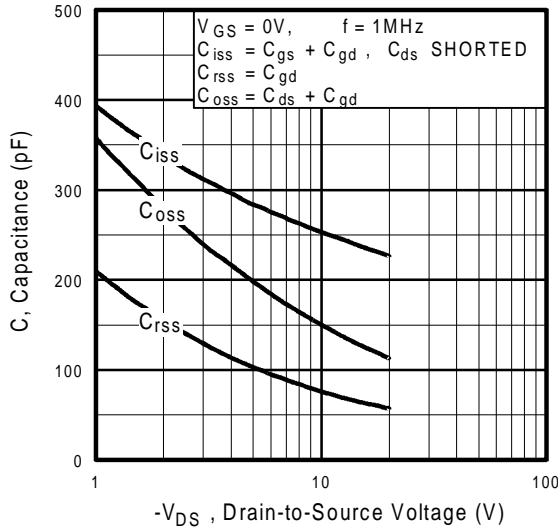
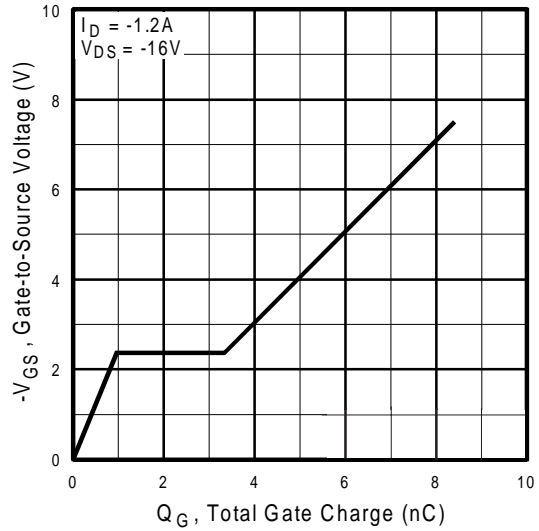


Fig 4. Normalized On-Resistance Vs. Temperature

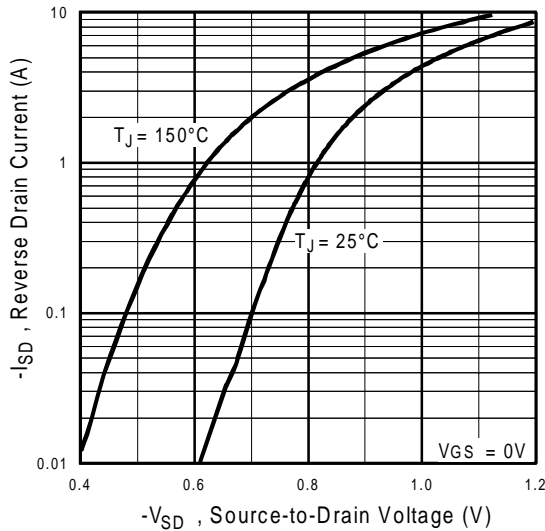
**Power Mosfet Characteristics**



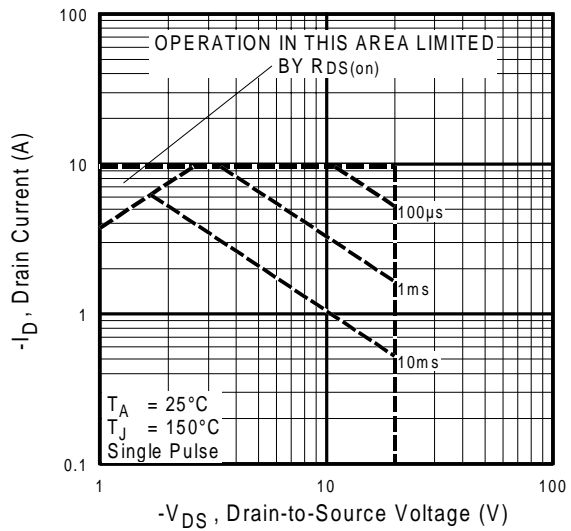
**Fig 5.** Typical Capacitance Vs. Drain-to-Source Voltage



**Fig 6.** Typical Gate Charge Vs. Gate-to-Source Voltage



**Fig 7.** Typical Source-Drain Diode Forward Voltage



**Fig 8.** Maximum Safe Operating Area

Power Mosfet Characteristics

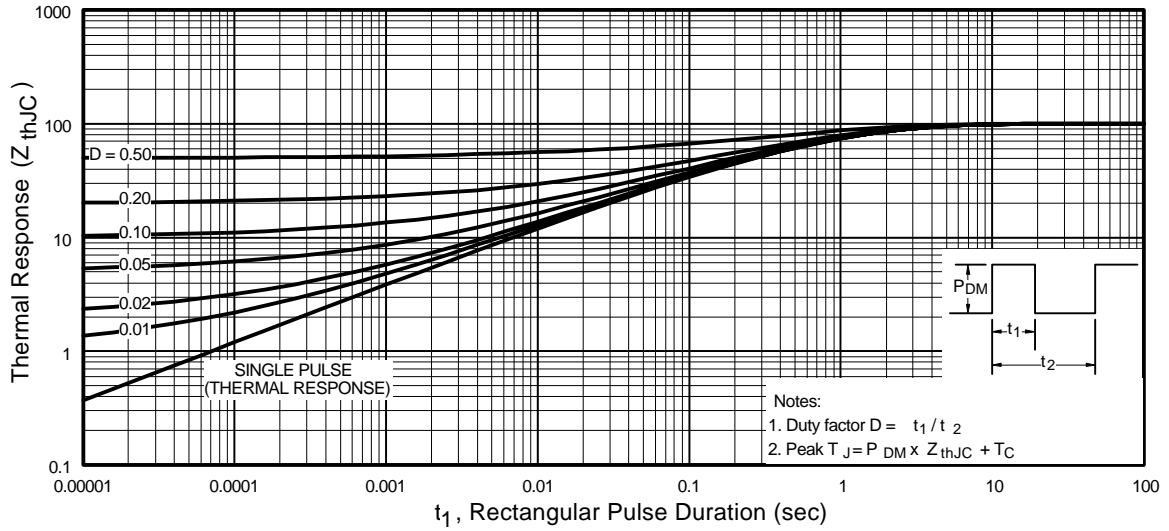


Fig 9. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

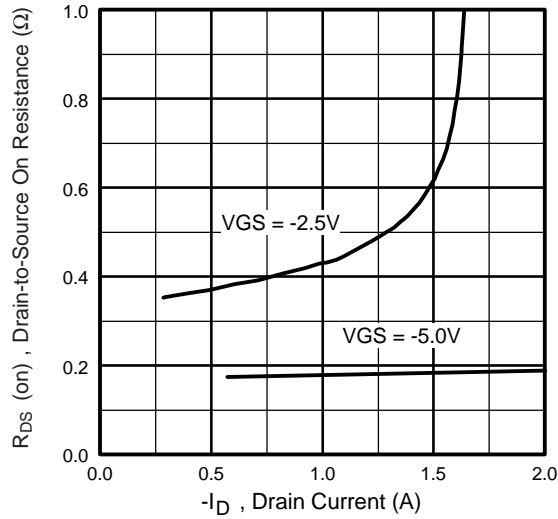


Fig 10. Typical On-Resistance Vs. Drain Current

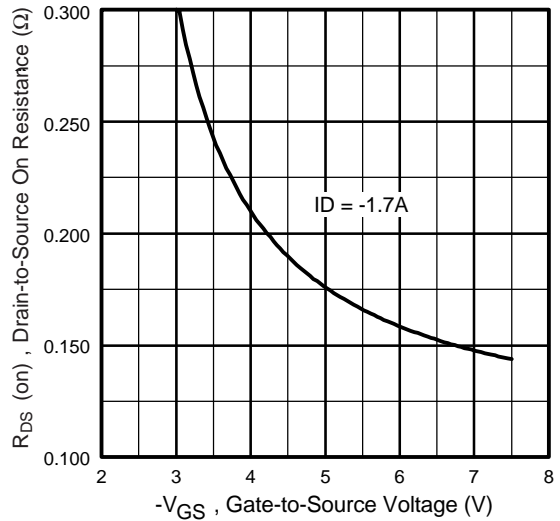


Fig 11. Typical On-Resistance Vs. Gate Voltage

Schottky Diode Characteristics

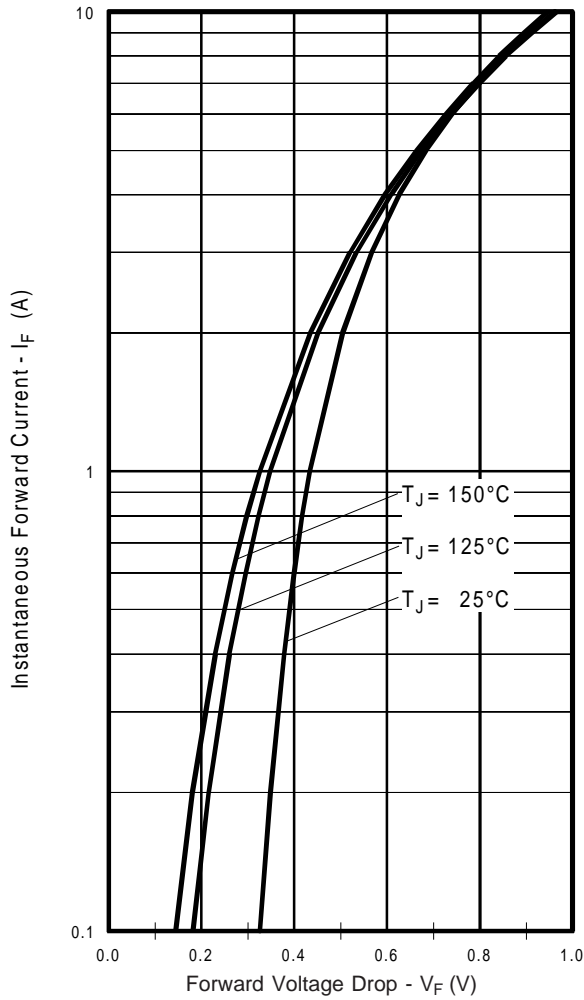


Fig. 12 - Typical Forward Voltage Drop Characteristics

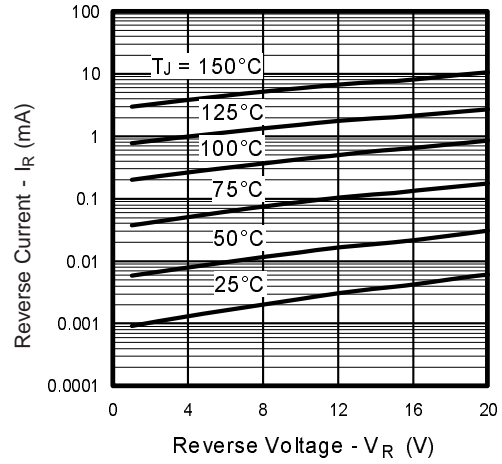


Fig. 13 - Typical Values of Reverse Current Vs. Reverse Voltage

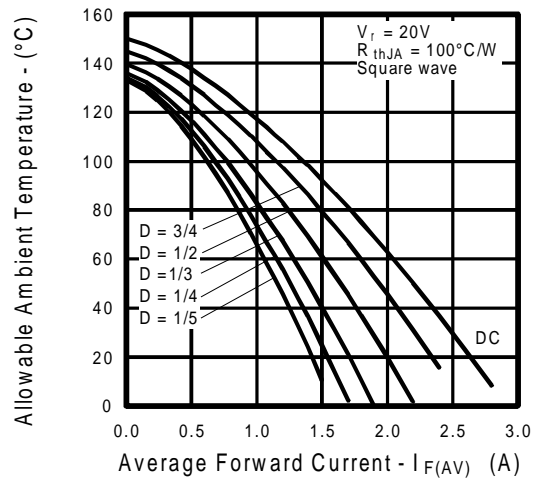
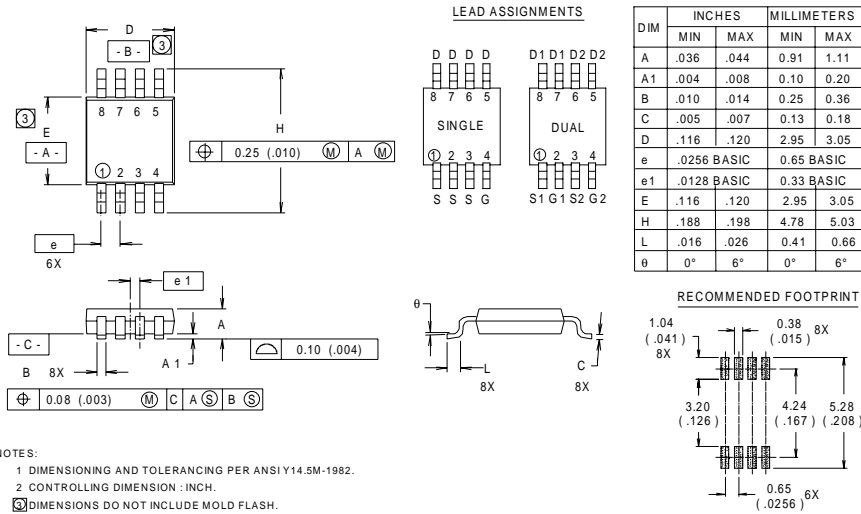


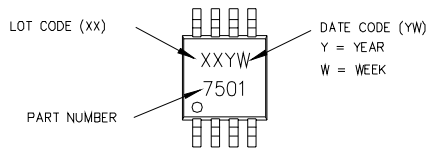
Fig.14 - Maximum Allowable Ambient Temp. Vs. Forward Current

Micro8™ Package Details



Part Marking

EXAMPLE: THIS IS AN IRF7501



WW = (1-26) IF PRECEDED BY LAST DIGIT OF CALENDAR YEAR

DATE CODE EXAMPLES:

YWW = 9503 = 5C  
YWW = 9532 = EF

YEAR	Y	WORK WEEK	W
2001	1	01	A
2002	2	02	B
2003	3	03	C
1994	4	04	D
1995	5		
1996	6		
1997	7		
1998	8		
1999	9		
2000	0	24	X
		25	Y
		26	Z

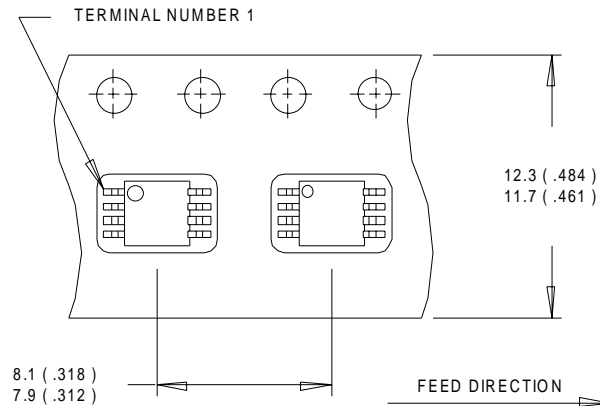
WW = (27-52) IF PRECEDED BY A LETTER

YEAR	Y	WORK WEEK	W
2001	A	27	A
2002	B	28	B
2003	C	29	C
1994	D	30	D
1995	E		
1996	F		
1997	G		
1998	H		
1999	J		
2000	K	50	X
		51	Y
		52	Z

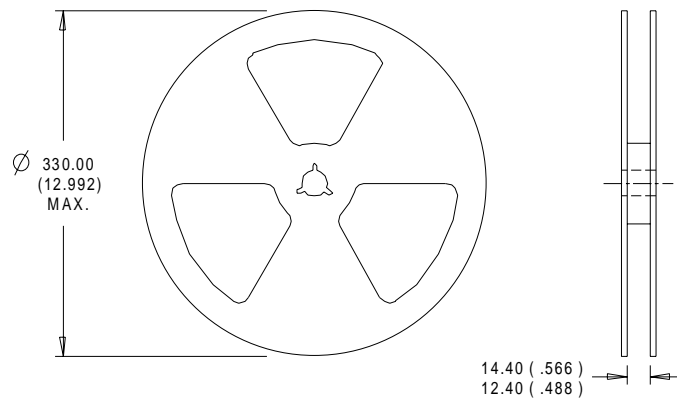
# IRF7524D1

International  
**IR** Rectifier

## Micro8™ Tape & Reel



- NOTES:
1. OUTLINE CONFORMS TO EIA-481 & EIA-541.
  2. CONTROLLING DIMENSION : MILLIMETER.



- NOTES :
1. CONTROLLING DIMENSION : MILLIMETER.
  2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

International  
**IR** Rectifier

**WORLD HEADQUARTERS:** 233 Kansas St., El Segundo, California 90245, Tel: (310) 322 3331

**IR GREAT BRITAIN:** Hurst Green, Oxted, Surrey RH8 9BB, UK Tel: ++ 44 1883 732020

**IR CANADA:** 15 Lincoln Court, Brampton, Ontario L6T3Z2, Tel: (905) 453 2200

**IR GERMANY:** Saalburgstrasse 157, 61350 Bad Homburg Tel: ++ 49 6172 96590

**IR ITALY:** Via Liguria 49, 10071 Borgaro, Torino Tel: ++ 39 11 451 0111

**IR FAR EAST:** K&H Bldg., 2F, 30-4 Nishi-Ikebukuro 3-Chome, Toshima-Ku, Tokyo Japan 171 Tel: 81 3 3983 0086

**IR SOUTHEAST ASIA:** 1 Kim Seng Promenade, Great World City West Tower, 13-11, Singapore 237994 Tel: ++ 65 221 8371

**IR TAIWAN:** 16 Fl. Suite D. 207, Sec. 2, Tun Haw South Road, Taipei, 10673, Taiwan Tel: 886-2-2377-9936

<http://www.irf.com/> Data and specifications subject to change without notice . 01/99



LittleDiode supplies new, hard to find or obsolete electronic components and semiconductors all over the world.

With over two million different components listed you are sure to find the part you need.

Feel free to visit us today at our online store:

[LittleDiode.com](http://LittleDiode.com)

Looking forward to providing you with the best possible service.